

Vishay Siliconix

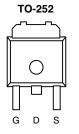
RoHS

COMPLIANT

HALOGEN

P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A)	Q _g (Typ.)		
- 40	0.0162 at V _{GS} = - 10 V	- 36	67		
- 40	0.0230 at V_{GS} = - 4.5 V	- 24	07		



Top View

Ordering Information: SUD45P04-16P-GE3 (Lead (Pb)-free and Halogen-free)

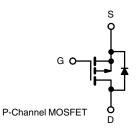
Drain Connected to Tab

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_a and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- · Load Switch in High Current Applications
- DC/DC Converters



ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, unless ot	herwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 40	v	
Gate-Source Voltage		V _{GS}	± 20	- v
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _C = 25 °C	1-	- 36	
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _C = 70 °C	I _D	- 29	
Pulsed Drain Current (t = 300 μs)		I _{DM}	- 100	— A
Avalanche Current		I _{AS}	- 32	
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	51	mJ
	T _C = 25 °C	Р	41.7 ^b	14/
Maximum Power Dissipation ^a	T _A = 25 °C ^c	- P _D -	2.1	— W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	60	°C/W		
Junction-to-Case (Drain)	R _{thJC}	3	C/VV		

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_{D} = -250 \mu A$	- 40		v		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1		- 2.5	v	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 250	nA	
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 40 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μΑ	
		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \leq$ - 10 V, V_{GS} = - 10 V	- 50			А	
	B	V _{GS} = - 10 V, I _D = - 14 A		0.0135	0.0162	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 12 A		0.0190	0.0230		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 20 V, I _D = - 14 A		40		S	
Dynamic ^b							
Input Capacitance	C _{iss}			2765		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = -20 V, f = 1 MHz$		330			
Reverse Transfer Capacitance	C _{rss}			280			
Total Gate Charge ^c	Qg			67	100	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -14 \text{ A}$		13.5			
Gate-Drain Charge ^c	Q _{gd}			14			
Gate Resistance	Rg	f = 1 MHz	0.5	2.5	5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			10	20		
Rise Time ^c	t _r	V_{DD} = - 20 V, R_L = 2 Ω		11	20		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		42	63	- ns	
Fall Time ^c	t _f			12	20		
Drain-Source Body Diode Ratings a	nd Characteri	stics T _C = 25 °C ^b					
Continuous Current	ا _S				- 36	٨	
Pulsed Current	I _{SM}				- 100	A	
Forward Voltage ^a	V _{SD}	I _F = - 10 A, V _{GS} = 0 V		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			38	57	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 10 A, dI/dt = 100 A/μs		2.3	3.5	Α	
Reverse Recovery Charge	Q _{rr}	1 1		40	60	nC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

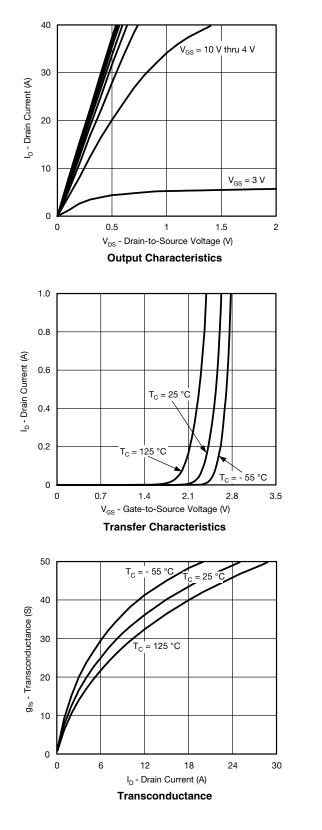
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

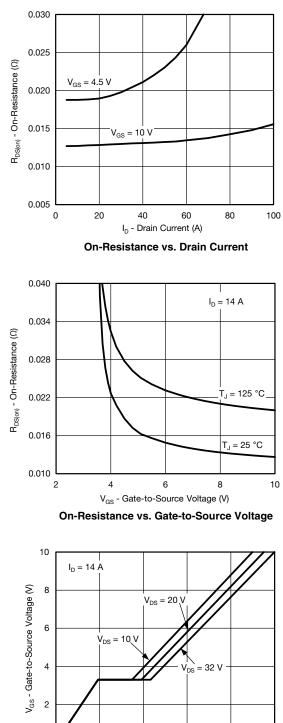
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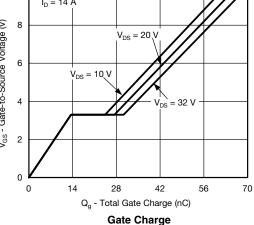


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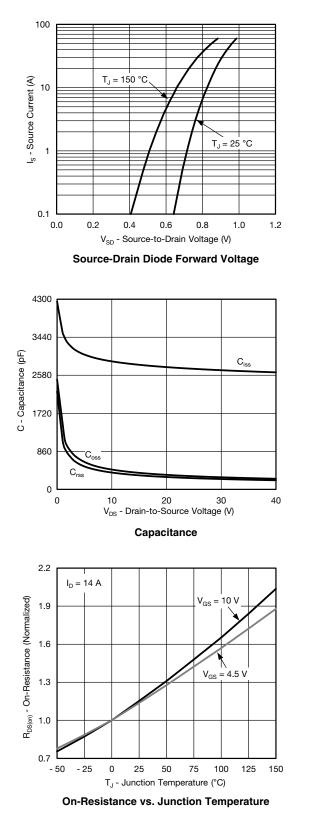


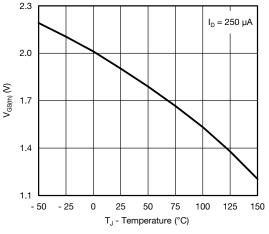
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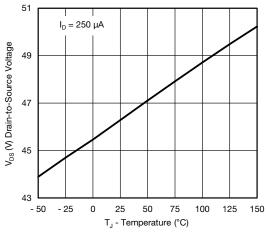


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

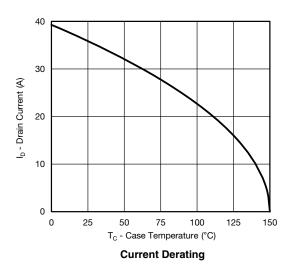




Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



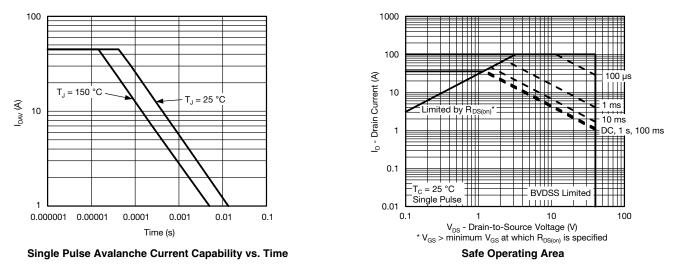
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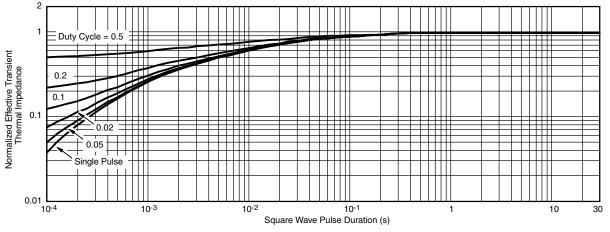
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63372.

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Е b3 Ľ Δ ŝ b2 e1 Б E1

C2 т gage plane height (0.5 mm) -C - A1

TO-252AA Case Outline

	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347					

Notes

• Dimension L3 is for reference only.

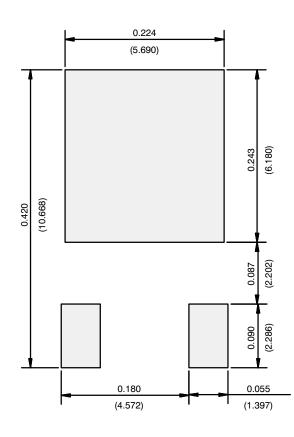
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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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